M

| Reg No.: | Name: |
|----------|-------|
| | |

APJ ABDUL KALAM TECHNOLOGICAL UNIVERSITY

Fourth Semester B.Tech (Minor) Degree Examination July 2021 (2019 admisssion)

Course Code: MET286

Course Name: MANUFACTURING TECHNOLOGY (MINOR)

Duration: 3 Hours Max. Marks: 100 PART A (Answer all questions; each question carries 3 marks) Marks 1 Explain any three properties required for the moulding sand. 3 2 Explain three types of pattern allowances in sand casting process. 3 3 3 Write a note on blending and mixing process in powder metallurgy. 4 Describe DCSP and DCRP arc welding processes. 3 5 3 Write a note on heat affected zone in a welding process and its significance. 6 Explain brazing process and list some applications of brazing process. 3 7 Compare the open die forging and the closed die forging processes with neat 3 sketches. 8 Explain the barrelling effect in the open die forging process. 3 9 What is an etchant? List some examples of etchants. 3 3 10 Compare the isotropic and the anisotropic etching processes. PART B (Answer one full question from each module, each question carries 14 marks) Module -1 11 Illustrate the investment casting process with neat sketches and list its 14 advantages and disadvantages. 12 Illustrate the die casting process with neat sketches and list its advantages and 14 disadvantages. Module -2 13 a) Explain any three powder production methods used in the powder metallurgy 9 process. b) Explain the impregnation and the infiltration processes in powder metallurgy. 5 Explain the plasma arc welding process with a neat sketch and list its 14 14 advantages and disadvantages.

02000MET286072102

Module -3

| 15 | | Explain the shielded metal arc welding process with a neat sketch and list its | 14 |
|----|----|--|----|
| | | advantages, disadvantages and applications. | |
| 16 | a) | Explain the torch brazing, the furnace brazing, the induction brazing and the | 8 |
| | | dip brazing processes. | |
| | b) | Compare the brazing and the soldering processes and list the applications of | 6 |
| | | each of the processes. | |
| | | Module -4 | |
| 17 | | Compare the direct, the indirect and the hydrostatic extrusion processes with | 14 |
| | | neat diagrams. | |
| 18 | | Explain the various types of the chemical vapour deposition processes. | 14 |
| | | Module -5 | |
| 19 | a) | Compare the surface micro machining and the bulk micro machining processes. | 8 |
| | b) | Explain the wet etching and the dry etching processes. | 6 |
| 20 | | Explain the various steps involved in the photolithography technique for the | 14 |
| | | making of a MEMS device. | |
